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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/725,053	12/02/2003	Tadahiro Kegasawa	Q78706	2949	
23373 7590 12/21/2006 SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W.			EXAM	EXAMINER .	
			EASHOO	EASHOO, MARK	
SUITE 800 WASHINGTON, DC 20037			ART UNIT	PAPER NUMBER	
	11, 20 20007		1732		
SHORTENED STATUTOR	Y PERIOD OF RESPONSE	MAIL DATE	DELIVER	DELIVERY MODE	
3 MONTHS		12/21/2006	PAF	PAPER	

# Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

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	Application No.	Applicant(s)
0.00	10/725,053	KEGASAWA ET AL.
Office Action Summary	Examiner	Art Unit
•	Mark Eashoo, Ph.D.	1732
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet wit	th the correspondence address
A SHORTENED STATUTORY PERIOD FOR REF WHICHEVER IS LONGER, FROM THE MAILING  - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  If NO period for reply is specified above, the maximum statutory perions are provided by the communication of the provided period for reply within the set or extended period for reply will, by state Any reply received by the Office later than three months after the main earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNIC 1.136(a). In no event, however, may a re od will apply and will expire SIX (6) MONT tute, cause the application to become ABA	CATION.  sply be timely filed  ITHS from the mailing date of this communication.  ANDONED (35 U.S.C. § 133).
Status		
1) Responsive to communication(s) filed on 10	October 2006.	
2a)⊠ This action is <b>FINAL</b> . 2b)□ Th	his action is non-final.	
3) Since this application is in condition for allow	vance except for formal matte	ers, prosecution as to the merits is
closed in accordance with the practice unde	r <i>Ex parte Quayle</i> , 1935 C.D.	. 11, 453 O.G. 213.
Disposition of Claims		
4)⊠ Claim(s) <u>1-5 and 10-17</u> is/are pending in the	application.	
4a) Of the above claim(s) is/are withd	rawn from consideration.	
5) Claim(s) is/are allowed.		
6)⊠ Claim(s) <u>1-5 and 10-17</u> is/are rejected.		
7) Claim(s) is/are objected to.		
8) Claim(s) are subject to restriction and	d/or election requirement.	
Application Papers		
9)☐ The specification is objected to by the Exami	ner.	
10) The drawing(s) filed on is/are: a) a	ccepted or b) ☐ objected to b	by the Examiner.
Applicant may not request that any objection to the	• • • • • • • • • • • • • • • • • • • •	, ,
Replacement drawing sheet(s) including the corre	· · · · · · · · · · · · · · · · · · ·	
11) The oath or declaration is objected to by the	Examiner. Note the attached	Office Action or form PTO-152.
Priority under 35 U.S.C. § 119		
12)⊠ Acknowledgment is made of a claim for foreign	gn priority under 35 U.S.C. §	119(a)-(d) or (f).
a)⊠ All b)□ Some * c)□ None of:		
<ol> <li>Certified copies of the priority docume</li> </ol>	ents have been received.	
2. Certified copies of the priority docume	·	·
3. Copies of the certified copies of the pr	•	received in this National Stage
application from the International Bure	. , , ,	and the said
* See the attached detailed Office action for a li	st of the certified copies not r	eceivea.
	•	
March cont/c)		
Machment(s)		
uttachment(s) )		ummary (PTO-413)
	Paper No(s)	ummary (PTO-413) /Mail Date formal Patent Application

Application/Control Number: 10/725,053

Art Unit: 1732

#### **DETAILED ACTION**

#### Claim Rejections - 35 USC § 102

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Peiffer et al. (US Pat. 5,716,570).

Peiffer et al. teaches the claimed process of forming a film, comprising: joining a middle portion and edge portions of a film, in a molten state, such that the edge portion enclose both edges of the film main body (Fig. 3); extruding the joined resins through a die to form a film (Fig. 3); and wherein a boundary is formed between first and second layers (Fig. 3).

Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Cloeren (US Pat. 5,120,484).

Cloeren teaches the claimed process of forming a film, comprising: joining a middle portion and edge portions of a film, in a molten state, such that the edge portion enclose both edges of the film main body (Figs. 4-5); extruding the joined resins through a die to form a film (Figs. 4-5); and wherein a boundary is formed between first and second layers (Figs. 4-5).

### Claim Rejections - 35 USC § 103

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

Claims 2-5 and 10-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Peiffer et al. (US Pat. 5,716,570) in view of Kegasawa et al. (US Pat. 6,203,742).

Peiffer et al. teaches the basic claimed process as set forth above regarding claim 1.

Peiffer et al. does not teach adjusting the degree of enclosing according to a difference in MFR, temperature, extrusion rate, or film/die width. However, Kegasawa et al. suggest that it is critical/necessary to know the relationship between rheological characteristics (ie. viscosity, MFR, etc.), temperature, and flow rate in order to balance the extrusion pressure along the width of the film/die, including the pressure difference at the ends of the die/film (4:20-5:22). It is noted that MFR is directly related to viscosity and a person of ordinary skill in the art would readily be able to make the association between the two terms. Furthermore, since Kegasawa et al. refers to adjusting the pressure across the die width by varying the other

aforementioned parameters, "adjustment of the width" is readable or intrinsic upon adjustment of the other parameters. Peiffer et al. and Kegasawa et al. are combinable because they are from the same field of endeavor, namely, flat film extrusion. At the time of invention a person of ordinary skill in the art would have found it obvious to have adjusted the either the viscosity/MFR, temperature, or flow rate, as taught by Kegasawa et al., in the process of Peiffer et al., in order to adjust the size and degree of confluence/intermingling of the different resins. Lastly, with respect to claims 10-17, the limitations "is large" or "is small" are relative terms of degree and therefore are implicitly met by the differences in material parameters as taught by each of the applied references.

Claims 2-5 and 10-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cloeren (US Pat. 5,120,484) in view of Kegasawa et al. (US Pat. 6,203,742).

Cloeren teaches the basic claimed process as set forth above regarding claim 1.

Cloeren does not teach adjusting the degree of enclosing according to a difference in MFR, temperature, extrusion rate, or film/die width. However, Kegasawa et al. suggest that it is critical/necessary to know the relationship between rheological characteristics (ie. viscosity, MFR, etc.), temperature, and flow rate in order to balance the extrusion pressure along the width of the film/die, including the pressure difference at the ends of the die/film (4:20-5:22). It is noted that MFR is directly related to viscosity and a person of ordinary skill in the art would readily be able to make the association between the two terms. Furthermore, since Kegasawa et al. refers to adjusting the pressure across the die width by varying the other aforementioned parameters, "adjustment of the width" is readable or intrinsic upon adjustment of the other parameters. Cloeren and Kegasawa et al. are combinable because they are from the same field of endeavor, namely, flat film extrusion. At the time of invention a person of ordinary skill in the art would have found it obvious to have adjusted the either the viscosity/MFR, temperature, or flow rate, as taught by Kegasawa et al., in the process of Cloeren, in order to adjust the size and degree of confluence/intermingling of the different resins. Lastly, with respect to claims 10-17, the limitations "is large" or "is small" are relative terms of degree and therefore are implicitly met by the differences in material parameters as taught by each of the applied references.

## Response to Arguments

Applicant's arguments with respect to Thompson and claims 1-5 and 10-17 have been considered but are most in view of the new ground(s) of rejection.

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#### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

#### Correspondence

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Mark Eashoo, Ph.D. whose telephone number is (571) 272-1197. The examiner can normally be reached on 7am-3pm EST, Monday - Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Christina Johnson can be reached on (571) 272-1176. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

December 19, 2006

Mark Eashoo, Ph.D. Primary Examiner

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